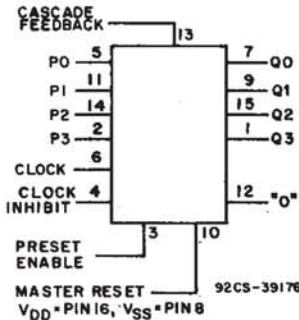


**NOT
RECOMMENDED FOR
NEW DESIGNS**

CD4522B Types

**Advance Information/
Preliminary Data**



FUNCTIONAL DIAGRAM

CMOS Programmable BCD Divide-by-"N" Counter

High-Voltage Types (20-Volt Rating)

Features:

- Internally synchronous for high internal and external speeds.
- Logic edge-clocked design — increments on positive Clock transition or on negative Clock Inhibit transition.
- 100% tested for quiescent current at 20-V.
- 5-V, 10-V, and 15-V parametric ratings.

- Standard symmetrical output characteristics.
- Maximum input current of 1 μ A at 18 V over full package-temperature range: 100 nA at 18 V and 25°C.
- Meets all requirements of JEDEC Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices."

■ CD4522B programmable BCD counter has a decoded "0" state output for divide-by-N applications. In single stage operation the "0" output is tied to the Preset Enable input. The Cascade Feedback allows multiple stage divide-by-N operation without the need for external gating. A HIGH on the Clock Inhibit disables the pulse-counting function. A HIGH on the Master Reset asynchronously resets the divide-by-N operation. The output is presented in BCD format.

The CD4522B-series types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Applications:

- Frequency synthesizers
- Phase-locked loops
- Programmable down counters
- Programmable frequency dividers

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal)

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to +20V

DC INPUT CURRENT, ANY ONE INPUT -0.5V to V_{DD} +0.5V

POWER DISSIPATION PER PACKAGE (P_D):

For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ 500mW

For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ Derate Linearly at 12mW/ $^\circ\text{C}$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$ 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to +125°C

STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to +150°C

LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max +265°C

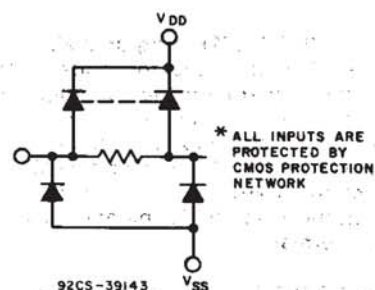
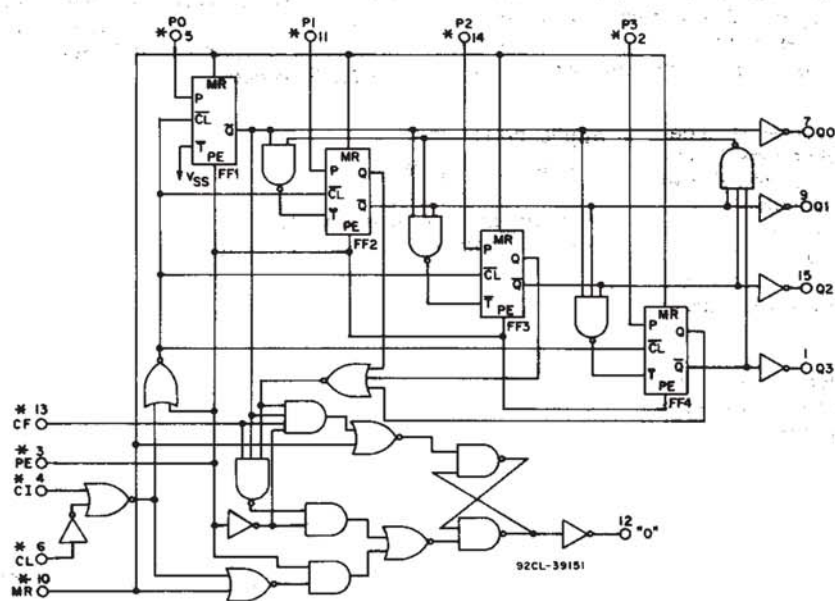
Trial	Control	MCI	AD
1	85	75	65
2	88	78	68
3	90	80	70
4	92	82	72
5	95	85	75

TRUTH TABLES

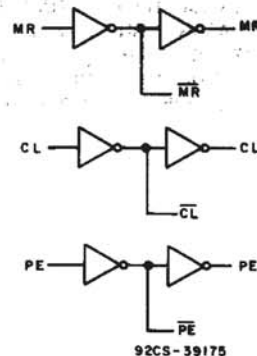
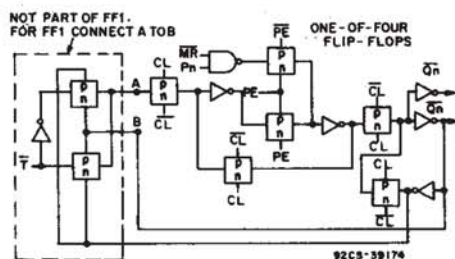
CLOCK	CLOCK INHIBIT	PRESET ENABLE	MASTER RESET	ACTION
0	0	0	0	No Count
	0	0	0	Count Down
X	1	0	0	No Count
1		0	0	Count Down
X	X	1	0	Preset
X	X	X	1	Reset

X = Don't Care

Count	OUTPUTS			
	Q ₀	Q ₁	Q ₂	Q ₃
0	0	0	0	0
1	1	0	0	0
2	0	1	0	0
3	1	1	0	0
4	0	0	1	0
5	1	0	1	0
6	0	1	1	0
7	1	1	1	0
8	0	0	0	1
9	1	0	0	1



a. *Basic diagram.*



b. Flip-flop detail.

Fig. 1 - Logic diagram for the CD4522B.

CD4522B Types

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^\circ\text{C}$, except as noted.

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTICS	V_{DD} (V)	LIMITS		UNITS
		Min.	Max.	
Supply-Voltage Range (For T_A = Full Package-Temperature Range)		3	18	V
Pulse Width:	5	250	—	ns
Clock, $t_{w(cc)}$	10	100	—	
	15	80	—	
Preset Enable, $t_{w(cc)}$	5	250	—	ns
	10	100	—	
	15	80	—	
Master Reset, $t_{w(MR)}$	5	350	—	ns
	10	250	—	
	15	200	—	
Clock Frequency, f_{CL}	5	—	1.5	MHz
	10	—	3.0	
	15	—	4.0	
Clock Rise and Fall Time t_{rCL}, t_{fCL}	5	—	15	μs
	10	—	15	
	15	—	15	
Preset Enable Set-up Time, t_{su}	5	0	—	ns
	10	0	—	
	15	0	—	
Preset Enable Hold Time, t_h	5	75	—	ns
	10	25	—	
	15	20	—	
Master Reset Removal Time, t_{rem}	5	130	—	ns
	10	50	—	
	15	30	—	

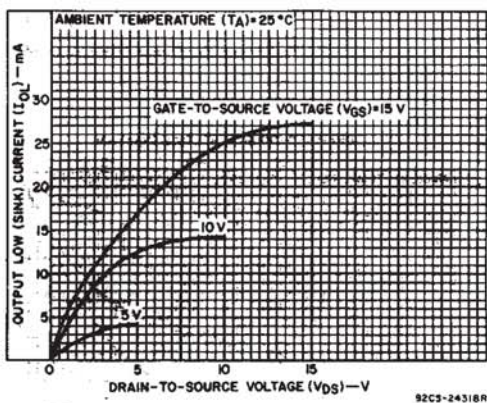


Fig. 2 — Typical output low (sink) current characteristics.

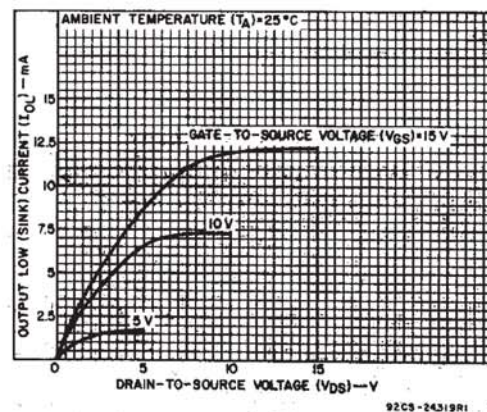


Fig. 3 — Minimum output low (sink) current characteristics.

CD4522B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER- ISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	+25							
				-55	-40	+85	+125	Min.	Typ.	Max.	
Quiescent Device	—	0, 5	5	5	5	150	150	—	0.04	5	μA
Current, I _{DD} Max.	—	0, 10	10	10	10	300	300	—	0.04	10	
	—	0, 15	15	20	20	600	600	—	0.04	20	
	—	0, 20	20	100	100	3000	3000	—	0.08	100	
Output Low	0.4	0, 5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
(Sink) Current	0.5	0, 10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
I _{OL} Min.	1.5	0, 15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Output High	4.6	0, 5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	
(Source)	2.5	0, 5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	V
Current,	9.5	0, 10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	
I _{OH} Min.	13.5	0, 15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	
Output Voltage:	—	0, 5	5	0.05				—	0	0.05	
Low-Level,	—	0, 10	10	0.05				—	0	0.05	V
V _{OL} Max.	—	0, 15	15	0.05				—	0	0.05	
Output Voltage:	—	0, 5	5	4.95				4.95	5	—	
High-Level	—	0, 10	10	9.95				9.95	10	—	
V _{OH} Min.	—	0, 15	15	14.95				14.95	15	—	V
Input low	0.5, 4.5	—	5	1.5				—	—	1.5	
Voltage, V _{IL} Max.	1, 9	—	10	3				—	—	3	
	1.5, 13.5	—	15	4				—	—	4	
Input High	0.5, 4.5	—	5	3.5				3.5	—	—	V
Voltage, V _{IH} Min.	1, 9	—	10	7				7	—	—	
	1.5, 13.5	—	15	11				11	—	—	
Input Current, I _{IN} Max.	—	0, 18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	

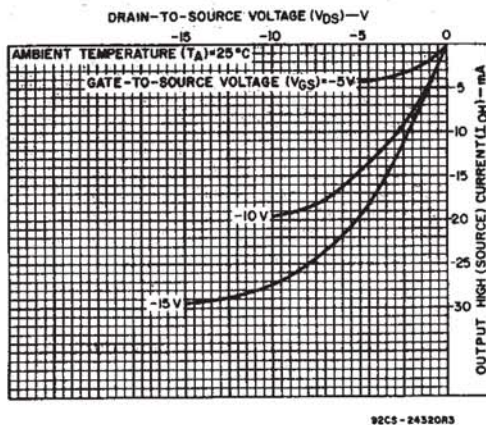


Fig. 4 — Typical output high (source) current characteristics.

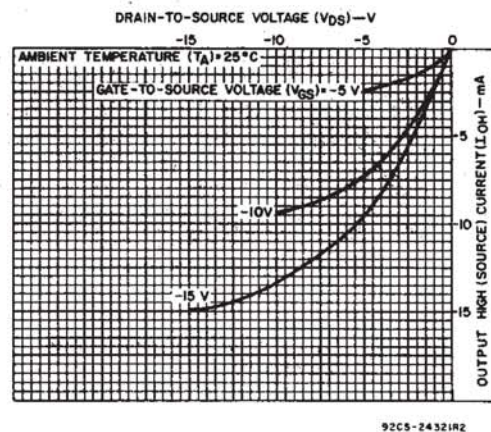


Fig. 5 — Minimum output high (source) current characteristics.

CD4522B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20\text{ ns}$, $C_i = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS			UNITS	
		V _{DD} (V)	Min.	Typ.		Max.
Propagation Delay Time; t _{PHL} , t _{PLH} : Clock to "Q" outputs		5	—	550	1100	ns
		10	—	225	450	
		15	—	160	320	
Clock to "0" output		5	—	420	710	ns
		10	—	160	270	
		15	—	110	190	
Clock inhibit to "Q" outputs		5	—	270	540	ns
		10	—	100	200	
		15	—	70	140	
Master reset to "Q" outputs		5	—	270	540	ns
		10	—	100	200	
		15	—	70	140	
Preset Enable Setup Time, t _{su}		5	—	0	0	ns
		10	—	0	0	
		15	—	0	0	
Preset Enable Hold Time, t _h		5	—	75	150	ns
		10	—	25	50	
		15	—	20	40	
Master Reset Removal Time, t _{rem}		5	—	130	260	ns
		10	—	50	100	
		15	—	30	60	
Transition Time, t _{THL} , t _{TLH}		5	—	100	200	ns
		10	—	50	100	
		15	—	40	80	
Minimum Pulse Width Clock, t _{W(CL)}		5	—	125	250	ns
		10	—	50	100	
		15	—	40	80	
Preset Enable, t _{W(PE)}		5	—	125	250	ns
		10	—	50	100	
		15	—	40	80	
Master Reset, t _{W(MR)}		5	—	175	350	ns
		10	—	125	250	
		15	—	100	200	
Max Clock Freq, f _{CL}		5	—	3	1.5	MHz
		10	—	6	3.0	
		15	—	8	4.0	
Max Clock or Clock Inhibit Rise & Fall Time, t _{TLH} , t _{THL}		5	—	—	15	us
		10	—	—	15	
		15	—	—	15	
Input Capacitance, C _{IN}	Any Input		—	5	7.5	pF

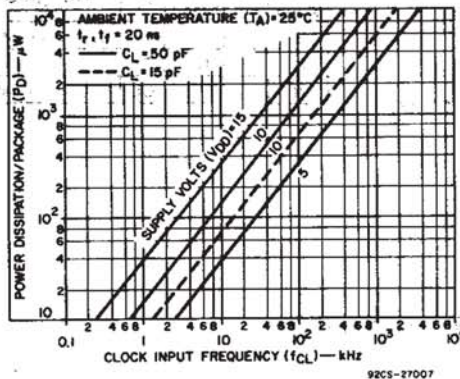
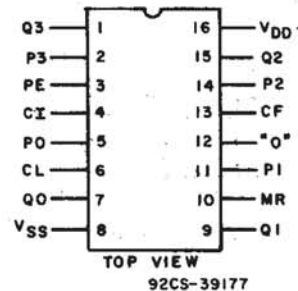


Fig. 6 — Typical dynamic power dissipation vs. frequency.



TERMINAL ASSIGNMENT

CD4522B Types

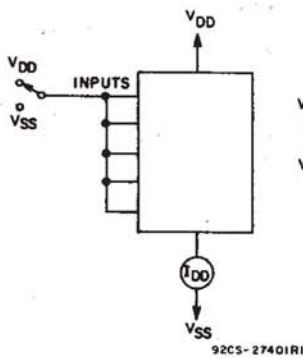


Fig. 7 — Quiescent device current test circuit.

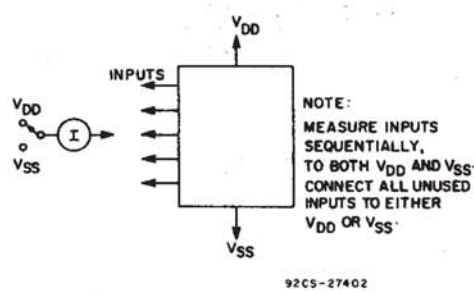


Fig. 8 — Input current test circuit.

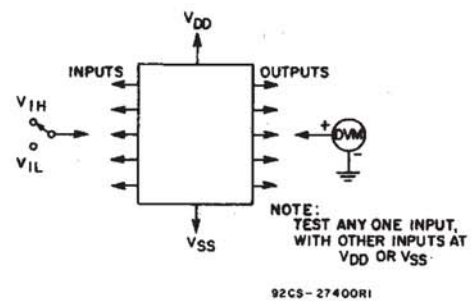


Fig. 9 — Input voltage test circuit.

APPLICATION CIRCUITS

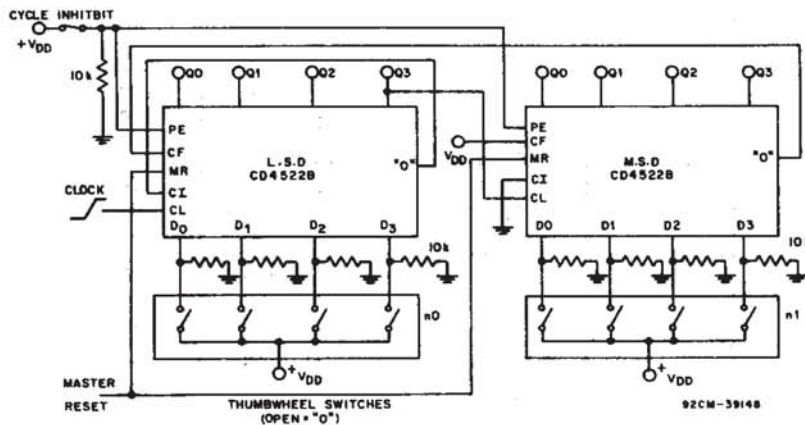


Fig. 10 — 2-Stage Programmable Down Counter (One Cycle)

From		To		Range of N
Stage	Pin	Stage	Pin	
LSD	"0"	All	PE	$LSD < N < MSD$
N	"0"	N-1	CF	$LSD + 1 < N < MSD$
N	"0s"	N+1	CL	$LSD < N < MSD-1$

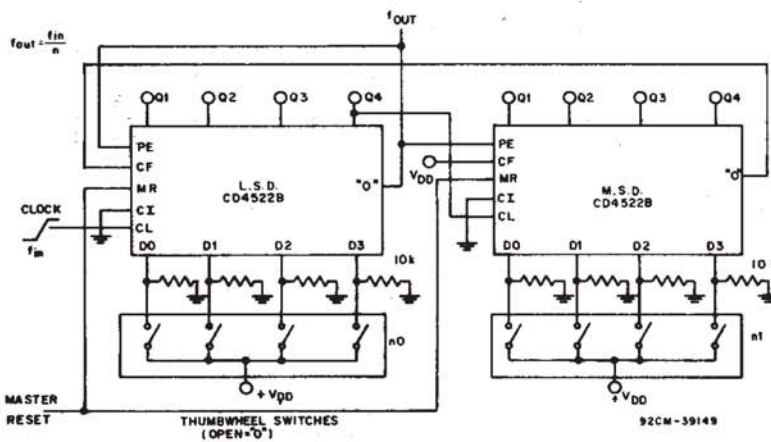


Fig. 11 — 2-Stage Programmable Frequency Divider

From		To		Range of N
Stage	Pin	Stage	Pin	
LSD	"0"	All	PE	$LSD < N < MSD$
N	"0"	N-1	CF	$LSD + 1 < N < MSD$
N	"0s"	N+1	CL	$LSD < N < MSD-1$

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CD4522BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-55 to 125	CD4522BE	Samples
CD4522BEE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-55 to 125	CD4522BE	Samples
CD4522BM	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4522BM	Samples
CD4522BMT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4522BM	Samples
CD4522BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM522B	Samples
CD4522BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM522B	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

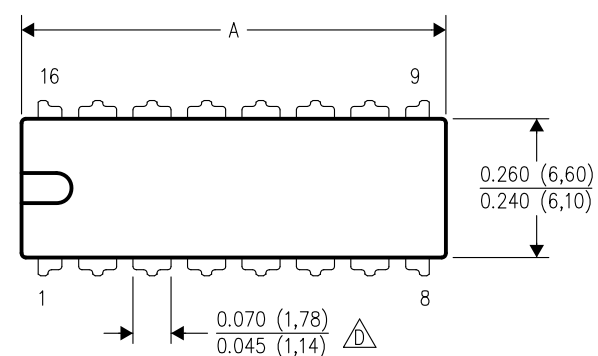
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

MECHANICAL DATA

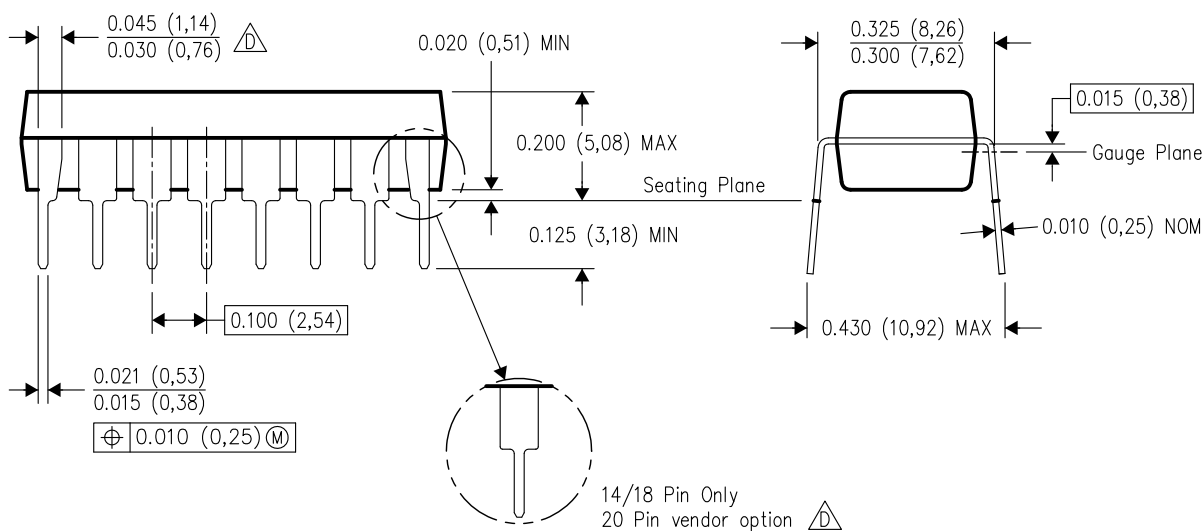
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
-  The 20 pin end lead shoulder width is a vendor option, either half or full width.